DAU Student Research Excellence Award

Objective:

To recognize and celebrate the achievement of the student-led original research that has resulted in publication at a reputed journal or a leading conference.

Award:

Award comprises a certificate and plaque/medal. The award is presented by the Director General annually (the day before the convocation ceremony each year) to the students who have published in high quality journals/conferences.

Eligibility Criteria:

All Undergraduate (UG), Postgraduate (PG), and PhD scholars of DAU – either currently enrolled or graduated within one year prior to the upcoming award ceremony – are eligible for this award, provided they have a research paper published in a journal or conference classified under Category I or Category II, as defined below:

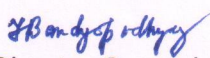| Category	Description
I	Q1 journals as per Scimago ranking, or A* or A ranked conferences as per either Core.edu or Aminer
II	Q2 journals as per Scimago ranking, or B ranked conferences as per either Core.edu or Aminer, or in one of the DAU Approved conferences

Notes:

- Refer to Appendix A for a list of DAU Approved conferences.

- The primary affiliation of the student – as listed the published paper – is required to be DA-IICT or DAU.

- To be eligible for an award during the Pre-Convocation Day ceremony held in year Y, the publication date (as per the DOI) must be between January 1 and December 31 of the calendar year Y–1.

- Only those conference papers published in the main technical track of the conference (excluding the workshops, tutorials, invited talks, etc.) are eligible.

- When a paper is published, and its DOI is listed, the student can apply for this award by filling out this **Google Form**. The last date for submitting this form is the 3rd January of Year Y for the application to be considered for the award at the pre-convocation

ceremony to be held in the Year Y. However, students are encouraged to fill in the form as and when their paper is published.

- A student with one or more eligible publications will receive a single award, with an additional certificate provided for each individual paper beyond the first.

- The students who are selected to receive this award will be informed via email latest by 5th January of year Y. However, students who apply in advance will be informed within a few days of submitting their application. The list of the awardees will be uploaded on the DAU website. The students who cannot attend the award ceremony may contact the Research Officer for collecting the award at a later date.

28th May 2025

Director General

T. Bandyopadhyay
Director General
DAU, Gandhinagar

Annexure A: DAU Approved Conferences

ICC: IEEE International Conference on Communications
ISCAS: IEEE International Symposium on Circuits and Systems
SPCOM: Signal Processing and Communications Conference
NCC: National Communications Conference
COMSNETS: International Conference on COMmunication Systems & NETworkS
ANTS: IEEE International Conference on Advanced Networks and Telecommunications Systems

HiPC: IEEE International Conference on High Performance Computing
INDOCRYPT: International Conference on Cryptology in India
ISEC: Innovations in Software Engineering
ITSC: International Conf on Intelligent Transportation Systems
ICVGIP: Indian Conference on Vision Graphics and Image Processing
ICDCN: International Conference on Distributed Computing and Networking
PReMI: International Conference on Pattern Recognition and Machine Intelligence
CVIP: International Conference on Computer Vision & Image Processing
ICISS: International Conference on Information Systems Security
FSEN: International Conference on Fundamentals of Software Engineering
TASE: Theoretical Aspects of Software Engineering
CoDS-COMAD: International Conference on Data Science
Web4 Good

ACC: American Control Conference
CDC: Conference on Decision and Control
VLSID: International Conference on VLSI Design
EPTC: Electronics Packaging Technology Conference
ECTC: Electronic Components and Technology
IEEE NANO: IEEE NANO
IEEE SAS: IEEE SAS
EDAPS: Electrical Design of Advanced Packaging and Systems
TENSYMP: IEEE Region 10 Symposium
IEEE SENSORS